

SCALE Dual-Channel Plug-and-Play Driver

Driver solution for 130mm x 140mm dual IGBT modules with fiber-optic interface for 2-level topologies

Abstract

The 2SB315B-2MBI1200U4G-170 is a dual-channel driver with a fiber-optic interface based on CONCEPT's dual SCALE driver 2SD315AI, a proven technology for reliable driving and safe operation of IGBTs.

The driver is matched to the 1700V module 2MBI1200U4G-170 from Fuji. Its plug-andplay capability makes it ready to operate immediately after mounting. The user needs invest no effort in designing or adjusting it to a specific application.

For drivers adapted to other types of high-power and high-voltage IGBT modules, refer to www.IGBT-Driver.com/go/plug-and-play

Product Highlights

- ✓ Suitable for 2MBI1200U4G-170
- ✓ Plug-and-play solution
- ✓ Active clamping of V_{ce} at turn-off
- ✓ IGBT short-circuit and overcurrent protection
- ✓ No electrolytic capacitors
- ✓ Fiber-optic interface
- ✓ Monitoring of power supply voltage
- ✓ Duty cycle 0... 100%
- ✓ Extremely reliable; long service life
- ✓ Shortens application development time

Applications

- ✓ Inverters
- ✓ Motor drives
- ✓ UPS
- ✓ Power-factor correctors
- Wind-power converters
- ✓ Welding
- ✓ SMPS
- and many others

IGBT-Driver.com



Important: Please refer to the relevant manuals!

This data sheet contains only product-specific data. A detailed description, must-read application notes and general data applicable to this driver family are found in: "Description and Application Manual for 2SB315B SCALE Plug-and-play IGBT Driver".

See www.IGBT-Driver.com/go/2SB315B

Dimensions

Dimensions: 130 x 145 mm, 21 mm height (30 mm with connector X1 and flat cable).

Mounting principle: Connected to IGBT module with screws.

Fiber Optics Interfaces

Interface	Remarks	Part type #
Drive signal input (Standard) Drive signal input (Opt. 01) Status output (Standard) Status output (Opt. 01)	Fiber-optic receiver (Notes 14,15) Fiber-optic receiver (Notes 14,17) Fiber-optic transmitter (Notes 14,16) Fiber-optic transmitter (Notes 14,18)	HFBR-2522Z HFBR-2412Z HFBR-1522Z HFBR-1412Z

Absolute Maximum Ratings

Parameter	Remarks	Min Max	Units
Supply voltage V_{DC}	VDC to GND (Note 1)	0 16	V
Supply voltage V_{DD}	VDD to GND	0 16	V
Gate peak current I_{out}	Note 6	-15 +15	Α
Average supply current I_{DC}	Notes 2,3	500	mA
Output power per gate	Note 3	3	W
Switching frequency	Note 3	14	kHz
DC-link voltage	Note 4	1200	V
Operating temperature	Note 3	-40 +85	°C
Storage temperature		-40 +90	°C

All data refer to +25°C and V_{DC} = 15V unless otherwise specified



Electrical Characteristics

Remarks	Min	Тур.	Max	Units
To GND (Note 1)		15		V_{dc}
Without load		80		mA
At 14 kHz switching frequen	су	500		mA
Internal DC/DC converter		85		%
		15		V_{dc}
				mA
•		130		mA
	су			
Standard				mA
Opt. 1		136		mA
Test conditions	Min	Тур.	Max	Units
Note 5		10.6		V _{dc}
Note 5		0.6		V_{dc}
Remarks	Min	Тур.	Max	units
Betw. aux. terminals		5.5		V
Note 7		10		μS
After failure (Note 8)		1		s
Test conditions	Min	Тур.	Max	Units
Note 9		420		ns
Note 9		550		ns
Gx to Ex (Note 10)		150		ns
Gx to Ex (Note 10)		80		ns
Half-bridge mode		2.5		μS
Test conditions	Min	Тур.	Max	Units
		5		Ω
		10		Ω
	To GND (Note 1) Without load At 14 kHz switching frequent Internal DC/DC converter To GND Without load Standard Opt. 1 At 14 kHz switching frequent Standard Opt. 1 Test conditions Note 5 Note 5 Remarks Betw. aux. terminals Note 7 After failure (Note 8) Test conditions Note 9 Note 9 Gx to Ex (Note 10) Gx to Ex (Note 10) Half-bridge mode	To GND (Note 1) Without load At 14 kHz switching frequency Internal DC/DC converter To GND Without load Standard Opt. 1 At 14 kHz switching frequency Standard Opt. 1 Test conditions Min Note 5 Note 5 Remarks Min Betw. aux. terminals Note 7 After failure (Note 8) Test conditions Min Note 9 Note 9 Gx to Ex (Note 10) Gx to Ex (Note 10) Half-bridge mode	To GND (Note 1)	To GND (Note 1) 15 Without load 80 At 14 kHz switching frequency 500 Internal DC/DC converter 85 To GND 15 Without load Standard 90 Opt. 1 130 At 14 kHz switching frequency Standard 96 Opt. 1 136 Test conditions Min Typ. Max Note 5 10.6 Note 5 0.6 Remarks Min Typ. Max Betw. aux. terminals 5.5 Note 7 10 After failure (Note 8) 1 Test conditions Min Typ. Max Note 9 420 Note 9 550 Gx to Ex (Note 10) 150 Gx to Ex (Note 10) 80 Half-bridge mode 2.5 Test conditions Min Typ. Max



Electrical insulation	Test conditions	Min Typ. Max	Units
Operating voltage	Continuous or repeated		V_{dc}
Test voltage Partial discharge extinction volt.	50 Hz/1 min (Note 11) IEC270 (Note 12)	4000 >1700	$V_{AC(eff)} \ V_{AC(pk)}$
Creep path input-output Creep path output-output		20 25	mm mm
Maximum dV/dt at dV=1000 V	Note 13	100	kV/µs
Collector current	Remarks	Min Typ. Max	Units
Max. IGBT collector current	Note 19	2300	А

All data refer to +25°C and V_{DC} = 15 V unless otherwise specified

Footnotes to the key data

- 1) The drivers have a zener diode on each channel for over-voltage protection. When the feed voltage exceeds 16V, this protection may be exposed to thermal overload.
- 2) If the specified power consumption is exceeded, this indicates an overload of the DC/DC converter. It should be noted that these DC/DC converters are not protected against overload.
- 3) Application-specific self-heating of gate drivers and IGBT modules, especially at high switching frequency, must be taken into account. As a rule, the switching frequency is limited due to the switching losses of the IGBT modules. Because CONCEPT cannot predict how the drivers will be incorporated in the user's application, no binding recommended value for self-heating and thus for the maximum useable output power can be made. Users are therefore recommended to check the gate driver's ambient temperature within the system.
- 4) This limit is due to active clamping. Refer to the "Description and Application Manual for 2SB315B SCALE Dual-Channel Plug-and-play IGBT Driver".
- 5) Under-voltage monitoring of the supply voltage to the gate driver. If the voltage drops below this limit, the power modules are switched off.
- 6) The gate current is limited by the gate resistors located on the driver.
- 7) Pulse width of the direct output of the gate drive unit (excluding the delay of the gate resistors).
- 8) The typical blocking time after an error is 1 second. Versions with other blocking times may also be supplied if required.
- 9) Measured from the transition of the turn-on or turn-off command at the host controller to direct output of the gate drive unit (excluding the delay of the gate resistors).
- 10) Refers to the direct output of the gate drive unit (excluding the delay of the gate resistors).
- 11) The test voltage of 4000 V_{ac(rms)}/50Hz may be applied only once during one minute. It should be noted that with this (strictly speaking obsolete) test method, some (minor) damage occurs to the insulation layers due to the partial discharge. Consequently, this test is not performed at CONCEPT as a series test. In the case of repeated insulation tests (e.g. module test, equipment test, system test), the subsequent tests should be performed with a lower test voltage: the test voltage is reduced by 400V for each additional test. The more modern if more elaborate partial-discharge measurement is preferable to such test methods as it is almost entirely non-destructive.
- 12) The partial discharge is not measured for the standard types. Tested and selected types with guaranteed partial-discharge immunity can be supplied for applications with maximum requirements and higher operating voltages (such as railroad applications).
- 13) This specification guarantees that the drive information will be transferred reliably even at a high DC-link voltage and with ultra-fast switching operations.



- 14) The transceivers required at the host controller side are not delivered with the gate driver. It is recommended to use the same types as used in the gate driver. For product information refer to www.IGBT-Driver.com/go/fiberoptics
- 15) The recommended transmitter current at the host controller is 30-35mA, suitable for plastic optic fibers with a length of less than 2.5 meters. Higher current may increase jitter or delay at turn-off.
- 16) The transmitter current at the gate driver is about 29mA.
- 17) The recommended transmitter current at the host controller is 60mA.
- 18) The transmitter current at the gate driver is about 53mA.
- 19) Due to the switching behaviour of the IGBT module and the response time of the IGBT driver the maximum collector current is limited to about 2300A at T_j =125°C and U_{dc} =1200V. At higher currents the desaturation protection of the driver will be activated at turn-on.

Important Notice

The data contained in this product data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Legal Disclaimer

This data sheet specifies devices but cannot promise to deliver any specific characteristics. No warranty or guarantee is given – either expressly or implicitly – regarding delivery, performance or suitability.

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Quality

The obligation to high quality is one of the central features laid down in the mission statement of CT-Concept Technologie AG. The quality management system covers all stages of product development and production up to delivery. The drivers of the SCALE series are manufactured to the ISO 9001 standard.



Ordering Information

The general terms and conditions of delivery of CT-Concept Technologie AG apply.

Related IGBT

CONCEPT Driver Type #

Fuji 2MBI1200U4G-170 2SB315B-2MBI1200U4G-170

Fuji 2MBI1200U4G-170 2SB315B-2MBI1200U4G-170 Opt. 01

Opt. 01: ST Fiber-optic interface (HFBR-2412Z and HFBR-1412Z), see "Description and Application Manual for 2SB315B SCALE Dual-Channel Plug-and-Play IGBT Drivers".

Information about Other Products

For drivers adapted to other high-voltage or high-power IGBT modules

Direct link: www.IGBT-Driver.com/go/plug-and-play

For other drivers and evaluation systems

Please click: www.IGBT-Driver.com

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